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Entrepreneurs M2 TechCast Podcasts

M2 TechCast: TiE's Gopalakrishan Outlines \$50,000 TiECon Midwest Connected Car, Mobility Competition

By Mike Brennan - September 7, 2016

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ROYAL OAK – Anu Gopalakrishan, Vice President of TiE Detroit, talks about the TiE-Autonebula Connected Car, Mobility Competition for Startups and the upcoming TiECon Midwest Conference October 27-28.

TiECon Midwest Conference will be held at the Henry, the former Ritz Carlton, and it will focus on connected transport. TiE is looking for six finalists who will be judged by senior managers from Bosch, Cisco, IBM and others. The deadline to apply is Oct. 5.

Gopalakrishan, who is Global Product Manager: Innovation for Ford Motor Credit Company, sees the power of mobile and wireless communications and how it is transforming the auto world. If you'd like to share her vision, and learn more about TiECon Midwest, click on <https://soundcloud.com/podcastdetroit/m2techcast-47-tie-detroit-event>

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